

60V, 600mA, Non-synchronous Buck Converter

### **Description**

The BL9366 is a monolithic, step-down, switch mode converter with a built-in power MOSFET. It achieves a 0.6A peak-output current over input supply 5.0V-60V with excellent load and line regulation. Current-mode operation provides a fast transient response and eases loop stabilization. Fault condition protections include cycle-by-cycle current limiting and thermal shutdown.

The BL9366 requires a minimal number of readily-available external components.

The BL9366 is available in a SOT23-6 package.

#### **Features**

- 0.6A Peak Output Current
- 0.9Ω Internal Power MOSFET
- Stable with Low-ESR Ceramic Output Capacitors
- Up to 90% Efficiency
- 0.1µA Shutdown Mode
- Fixed 480kHz Frequency
- Thermal Shutdown
- Cycle-by-Cycle Over-Current Protection
- 5.0V to 60V Operating Input Range
- Max duty 90%
- Available in a SOT23-6 Package

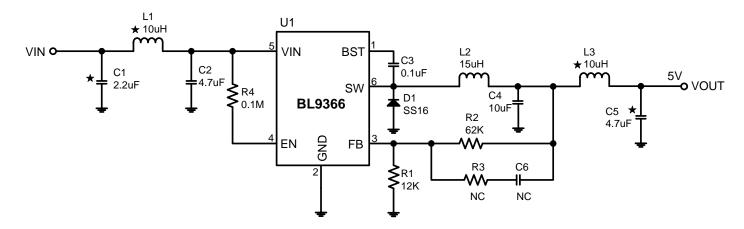
## **Applications**

- Power Meters
- Distributed Power Systems
- Battery Chargers
- Pre-Regulator for Linear Regulators
- WLED Drivers

### **Package**

• 6-pin SOT23-6

# **Typical Application Circuit**



Note: ★L1/C1 & L3/C5 are for EMI consideration and can be NC.

## **Ordering Information**

Part No.	Package	Tape&Reel
BL9366	SOT23-6	3000/Reel

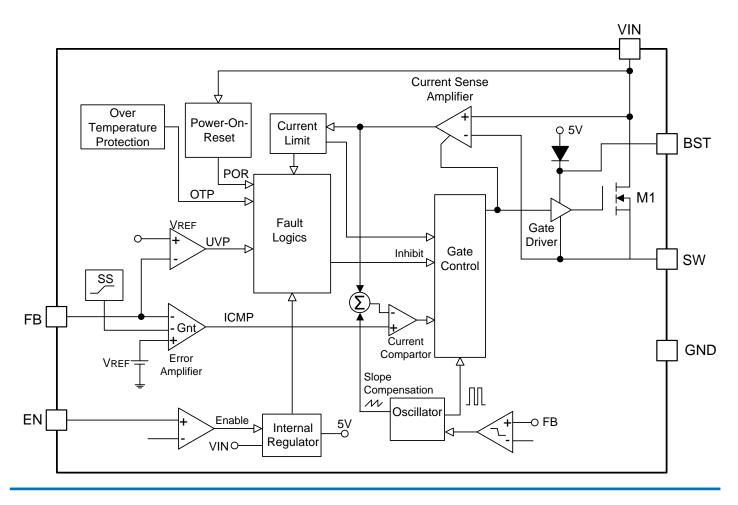
## **Marking Information**

Product Classification	BL9366
66: Product Code	SW VIN EN
Y stand for year, A=2022, B=2023, C=2024, D=2025	6 5 4 CCVAAV
M stand for month, A=Jan., B=Feb., C=Mar.,	66YMX 1 2 3
X stand for lot batch, 1=First batch, 2=Second batch, 3=Third batch,	BST GND FB

## **Pin Assignment**

Pin No.	Symbol	Function
		Bootstrap. Connect a capacitor between the SW and BST pins to form a floating
1	BST	supply across the power switch driver. This capacitor drivers the power switch's gate
		above the supply voltage.
		Ground. Voltage reference for the regulated output voltage. Requires special layout
2	GND	considerations. Isolate this node from the D1 to C1 ground path to prevent switching
		current spikes form inducing.
		Feedback. Set the output voltage. Connect to the tap of an external resistor driver
3	FB	from the output to GND. The frequency foldback comparator lowers the oscillator
3 FB		frequency when the FB voltage is below 250mV to prevent current-limit runaway
		during a short-circuit fault.
4	EN	On/Off. Pull EN above 1.35V to turn the device ON. For automatic enable, connect
4	EIN	to $V_{IN}$ using a $0.1 M\Omega$ resistor.
5	\/INI	Supply Voltage. Requires C1 to prevent large voltage spikes from appearing at the
5	VIN	input.
6	CM	Power switching output. It is the drain of the N-Channel power MOSFET to supply
6	SW	to the output LC filter.

# **Functional Block Diagram**



## **Absolute Maximum Ratings**

Parameter	Symbol	Rating	Unit
VIN Supply Voltage (VIN to GND)	V <sub>IN</sub>	-0.3 ~ 60	V
SW to GND Voltage	V <sub>SW</sub>	-6.5V 5Ns, -0.3 to V <sub>IN</sub> +0.3	V
BST to GND Voltage	V <sub>BST</sub>	V <sub>SW</sub> -0.3 ~ V <sub>SW</sub> +6	V
All other Pins Voltage		-0.3 ~6	V
Power Dissipation	$P_D$	Internally Limited	W
Junction-to-Ambient Resistance in Free Air (SOT23-6)	$\theta_{JA}$	250	°C/W
Maximum Junction Temperature	TJ	150	$^{\circ}$
Storage Temperature	T <sub>STG</sub>	-65 ~ +150	$^{\circ}$
Maximum Lead Soldering Temperature (10 Seconds)	T <sub>SDR</sub>	260	℃

#### Note:

- 1) Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operation Conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2)  $\theta_{JA}$  is measured with the component mounted on a high effective thermal conductivity test board in free air.

## **Recommended Operate Conditions**

Parameter	Symbol	Range	Unit
VIN Supply Voltage	$V_{IN}$	5.0 ~ 60	V
Converter Output Voltage	$V_{OUT}$	$V_{FB} \sim V_{IN}*85\%$	V
Operating Junction Temperature	TJ	-40 ~ +125	°C

#### Note:

#### **Electrical Characteristics**

 $V_{\text{IN}}\text{=}12\text{V},\,V_{\text{EN}}\text{=}3\text{V},\,T_{\text{A}}\text{=}25^{\circ}\text{C},\,\text{unless otherwise specified}.$ 

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Feedback Voltage	$V_{FB}$	5.0V≤V <sub>IN</sub> ≤60V	0.790	0.812	0.834	V
Feedback Current	I <sub>FB</sub>	V <sub>FB</sub> =0.85V			0.1	μΑ
Switch-on Resistance	R <sub>DS(ON)</sub>			0.9		Ω
Switch Leakage	I <sub>SW_LKG</sub>	V <sub>EN</sub> =0V, V <sub>SW</sub> =0V			1	μΑ
Current Limit	I <sub>LIM</sub>			1.35		Α
Oscillator Frequency	F <sub>SW</sub>	V <sub>FB</sub> =0.6V		480		kHz
Foldback Frequency	F <sub>SW_F</sub>	V <sub>FB</sub> =0V		150		kHz
Maximum Duty Cycle	D <sub>MAX</sub>	V <sub>FB</sub> =0.6V		90		%

<sup>3)</sup> Refer to the typical application circuit.

Minimum on Time	T <sub>ON</sub>			100		ns
Under-voltage Lockout Threshold, Rising	$V_{\text{UVLO}_{R}}$			3.3	3.73	V
Under-voltage Lockout Threshold, Falling	$V_{UVLO_{F}}$		2.6	3.0		V
Under-voltage Lockout Threshold, Hysteresis	V <sub>UVLO_HYS</sub>			0.3		V
EN Threshold, Rising	$V_{EN_{R}}$			1.35		V
EN Threshold, Falling	V <sub>EN_F</sub>			1.0		V
EN Threshold, Hysteresis	V <sub>EN_HYS</sub>			350		mV
EN Innut Cumout	ı	V <sub>EN</sub> =2V		3.0		μA
EN Input Current	I <sub>EN</sub>	V <sub>EN</sub> =0V		0.1		μA
Supply Current (Shutdown)	ls	V <sub>EN</sub> =0V		0.1	1	μA
Supply Current (Quiescent)	IQ	V <sub>EN</sub> =2V, V <sub>FB</sub> =1V		0.7	0.9	mA
Threshold Shutdown	T <sub>SD</sub>			165		°C
Threshold Shutdown Hysteresis	T <sub>SD_HYS</sub>			20		°C

### **Principle of Operation**

The BL9366 is a current mode buck regulator. That is, the EA output voltage is proportional to the peak inductor current. At the beginning of a cycle, M1 is off. The EA output voltage is higher than the current sense amplifier output, and the current comparator's output is low. The rising edge of the 480 kHz CLK signal sets the RS Flip-Flop. Its output turns on M1 thus connecting the SW pin and inductor to the input supply.

The increasing inductor current is sensed and amplified by the Current Sense Amplifier. Ramp compensation is summed to the Current Sense Amplifier output and compared to the Error Amplifier output by the PWM Comparator. When the sum of the Current Sense Amplifier output and the Slope Compensation signal exceeds the EA output voltage, the RS Flip-Flop is reset and M1is turned off. The external Schottky rectifier diode (D1) conducts the inductor current.

If the sum of the Current Sense Amplifier output and the Slope Compensation signal does not exceed the EA output for a whole cycle, then the falling edge of the CLK resets the Flip-Flop.

The output of the Error Amplifier integrates the voltage difference between the feedback and the 0.812V bandgap reference.

The polarity is such that lower than 0.812V FB pin voltage increases the EA output voltage. Since the EA output voltage is proportional to the peak inductor current, an increase in its voltage also increases current delivered to the output.

### **Application Information**

#### Set output voltage

The external resistor divider sets the output voltage (see the Typical Application schematic). Table 1 lists resistors for common output voltages. The feedback resistor (R2) also sets the feedback loop bandwidth with the internal compensation capacitor R1 is:

$$R1 = \frac{R2}{\frac{V_{OUT}}{0.812V} - 1}$$

Table 1: Resistor Selection for Common output voltages

V <sub>OUT</sub> (V)	R1(KΩ)	R2(KΩ)
1.8	102(1%)	124(1%)
2.5	59(1%)	124(1%)
3.3	40.2(1%)	124(1%)
5	23.7(1%)	124(1%)

#### Selecting the Inductor

Use an inductor with a DC current rating at least 25% percent higher than the maximum load current for most applications. For best efficiency, the inductor's DC resistance should be less than  $200m\Omega$ .

For most designs, the required inductance value can be derived from the following equation.

$$L = \frac{V_{OUT} * (V_{IN} - V_{OUT})}{V_{IN} * \Delta I_{L} * F_{SW}}$$

Where  $\Delta I_L$  is the inductor ripple current.

Choose the inductor ripple current to be 30% of the maximum load current. The maximum inductor peak current is:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_L}{2}$$

Under light-load conditions (below100mA), use a larger inductance to improve efficiency.

#### **Selecting the Input Capacitor**

The input capacitor reduces the surge current drawn from the input supply and the switching noise from the device. The input capacitor impedance at the switching frequency should be less than the input source impedance to prevent high-frequency-switching current from passing through the input. Use ceramic capacitors with X5R or X7R dielectrics for their low ESRs and small temperature coefficients. For most applications, a 4.7µF capacitor will sufficient.

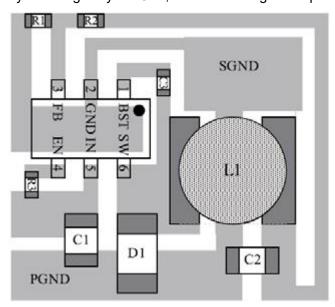
#### **Selecting the Output Capacitor**

The output capacitor keeps the output voltage ripple small and ensures feedback loop stability. The output capacitor impedance should be low at the switching frequency. Use ceramic capacitors with X5R or X7R dielectrics for their low ESR characteristics. For most applications, a 22uF ceramic capacitor will sufficient.

### **PCB Layout Guide**

PCB layout is very important to stability. Please follow these guidelines and use Figure 2 as reference.

- 1) Keep the path of switching current short and minimize the loop area formed by the input capacitor, high-side MOSFET and Schottky diode.
  - 2) Keep the connection from the power ground—Schottky diode—SW pin as short and wide as possible.
- 3) Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
  - 4) Route SW away from sensitive analog areas such as FB.
- 5)Connect IN, SW, and especially GND to large copper areas to cool the chip for improved thermal performance and long-term reliability. For single layer PCBs, avoid soldering the exposed pad.



# **Package Information**

A A 3 A A 2 A A 1 A 1 A 1 A 1 A 1 A 1 A 1 A 1	Package	SOT23-6	Devices per reel	3000 pcs
e b _		A A3 D e1	A2 C1 L L L L L L L L L L L L L L L L L L	

DIM	Millimeters		Incl	nes
DIM	Min	Max	Min	Max
А	1.05	1.45	0.0413	0.0571
A1	0	0.15	0.0000	0.0059
A2	0.9	1.3	0.0354	0.0512
A3	0.55	0.75	0.0217	0.0295
b	0.25	0.5	0.0098	0.0197
С	0.1	0.25	0.0039	0.0098
D	2.7	3.12	0.1063	0.1228
e1	1.9(7	ΓΥP)	0.0748(TYP)	
Е	2.6	3.1	0.1024	0.1220
E1	1.4	1.8	0.0551	0.0709
е	0.95(TYP)		0.0374	·(TYP)
L	0.25	0.6	0.0098	0.0236
θ	0	8°	0.0000	8°
c1	0.2(TYP)		0.0079	(TYP)